APPROVAL SHEET

MULTILAYER CERAMIC CAPACITORS

Middle & High Voltage Series (200V to 4kV)

0402 to 1812 Sizes

NP0, X7R & Y5V Dielectrics

Halogen Free & RoHS compliance

*Contents in this sheet are subject to change without prior notice.

1. INTRODUCTION

WTC middle and high voltage series MLCC is designed by a special internal electrode pattern, which can reduce voltage concentrations by distributing voltage gradients throughout the entire capacitor. This special design also affords increased capacitance values in a given case size and voltage rating.

Chips size 1206 and larger to use on reflow soldering process only. Capacitors with X7R dielectrics are not intended for AC line filtering applications. Capacitors may require protective surface coating to prevent external arcing.

2. FEATURES

a. High voltage in a given case size.
b. High stability and reliability.

3. APPLICATIONS

a. Snubbers in high frequency power converters.
b. High voltage coupling/DC blocking.
c. DC-DC converters.
d. Back-lighting inverters

4. HOW TO ORDER

1808	N	100	J	202	C	T
Size	**Dielectric**	**Capacitance**	**Tolerance**	**Rated voltage**	**Termination**	**Packaging**
Inch (mm) **0402** (1005) **0603** (1608) **0805** (2012) **1206** (3216) **1210** (3225) **1808** (4520) **1812** (4532)	**N**=NP0 (C0G) **B**=X7R **F**=Y5V	Two significant digits followed by no. of zeros. And R is in place of decimal point. eg.: 0R5=0.5pF 1R0=1.0pF 100=10x10^0 =10pF	**B**=±0.1pF **C**=±0.25pF **D**=±0.5pF **F**=±1% **G**=±2% **J**=±5% **K**=±10% **M**=±20% **Z**=-20/+80%	Two significant digits followed by no. of zeros. And R is in place of decimal point. **201**=200 VDC **251**=250 VDC **401**=400 VDC **451**=450 VDC **501**=500 VDC **631**=630 VDC **102**=1000 VDC **152**=1500 VDC **202**=2000 VDC **252**=2500 VDC **302**=3000 VDC **402**=4000 VDC	**C**=Cu/Ni/Sn	**T**=7" reeled **G**=13" reeled

5. EXTERNAL DIMENSIONS

Size Inch (mm)	L (mm)	W (mm)	T (mm)/Symbol		Remark	M_B (mm)
0402 (1005)	1.00±0.05	0.50±0.05	0.50±0.05	N	#	0.25 +0.05/-0.10
0603(1608)	1.60±0.10	0.80±0.10	0.80±0.07	S		0.40±0.15
	1.60 +0.15/-0.10	0.80 +0.15/-0.10	0.80 +0.15/-0.10	X		
0805 (2012)	2.00±0.15	1.25±0.10	0.60±0.10	A		0.50±0.20
			0.80±0.10	B		
			1.25±0.10	D	#	
	2.00±0.20	1.25±0.20	1.25±0.20	I	#	
1206 (3216)	3.20±0.15	1.60±0.15	0.80±0.10	B		0.60±0.20 (0.5±0.25)*
			0.95±0.10	C	#	
			1.25±0.10	D	#	
	3.20±0.20	1.60±0.20	1.60±0.20	G	#	
1210 (3225)	3.20±0.30	2.50±0.20	0.95±0.10	C	#	0.75±0.25
			1.25±0.10	D	#	
	3.20±0.40	2.50±0.30	1.60±0.20	G	#	
			2.00±0.20	K	#	
			2.50±0.30	M	#	
	3.20±0.60**	2.50±0.50**	2.50±0.50**			
1808 (4520)	4.50+0.5/-0.3	2.03±0.25	1.25±0.10	D	#	0.50±0.25
			2.00±0.20	K	#	
1812 (4532)	4.50+0.5/-0.3	3.20±0.30	1.25±0.10	D	#	0.50±0.25
			1.60±0.20	G	#	
			2.00±0.20	K	#	
		3.20±0.40	2.50±0.30	M	#	
			2.80±0.30	U	#	

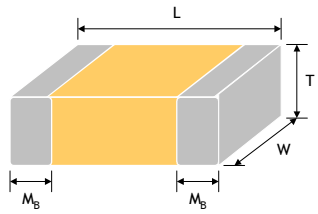


Fig. 1 The outline of MLCC

Reflow soldering only is recommended.
* For 1206_1000V ~3000V products.
** For 1210_100V: Cap > 1μF, 250V: Cap >0. 47μF, 400V~630V: Cap >0.22μF.

6. GENERAL ELECTRICAL DATA

Dielectric	NP0	X7R	Y5V
Size	0402, 0603, 0805, 1206, 1210, 1808, 1812		0805, 1206, 1210, 1812
Capacitance*	0.5pF to 0.033μF	100pF to 1.0μF	0.01μF to 0.68μF
Capacitance tolerance***	Cap≤5pF: C (±0.25pF) 5pF<Cap<10pF: D (±0.5pF) Cap≥10pF: F (±1%), G (±2%), J (±5%),K (±10%)	K (±10%), M (±20%)	Z (-20/+80%)
Rated voltage (WVDC)	200V to 4000V		200V, 250V
Q/DF*	Cap<30pF: Q≥400+20C Cap≥30pF: Q≥1000	DF≤2.5%	DF≤5%
Insulation resistance at Ur**	Ur=200~630V: ≥10GΩ or RxC≥100Ω-F whichever is smaller Ur=1000~3000V: ≥10GΩ		
Dielectric strength	200~300V: ≥2 x WVDC 400V~450V: ≥1.2 x WVDC 500~999V: ≥1.5 x WVDC 1000~3000V: ≥1.2 x WVDC 4000: ≥1.1 x WVDC		
Operating temperature	-55 to +125℃		-25 to +85℃
Capacitance characteristic	±30ppm	±15%	+30/-80%
Termination	Ni/Sn (lead-free termination)		

* Measured at the condition of 30~70% related humidity.
NP0: Apply 1.0±0.2Vrms, 1.0MHz±10% for Cap≤1000pF and 1.0±0.2Vrms, 1.0kHz±10% for Cap>1000pF, 25℃ at ambient temperature
X7R, X5R: Apply 1.0±0.2Vrms, 1.0kHz±10%, at 25℃ am bient temperature.
Y5V: Apply 1.0±0.2Vrms, 1.0kHz±10%, at 20℃ ambient temperature.
** Preconditioning for Class II MLCC: Perform a heat treatment at 150±10℃ for 1 hour, then leave in a mbient condition for 24±2 hours before measurement.

7. CAPACITANCE RANGE (MIDDLE VOLTAGE - 200V to 630V)

7-1 NP0 Dielectric

DIELECTRIC		NP0																					
SIZE		0402		0603		0805				1206				1210				1808		1812			
RATED VOLTAGE (VDC)		200	250	200	250	200	250	500	630	200	250	500	630	200	250	500	630	500	630	200	250	500	630
Capacitance	0.5pF (0R5)	N	N	S	S	A	A	A	A														
	1.0pF (1R0)	N	N	S	S	A	A	A	A														
	1.2pF (1R2)	N	N	S	S	A	A	A	A														
	1.5pF (1R5)	N	N	S	S	A	A	A	A	B	B	B	B										
	1.8pF (1R8)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	2.2pF (2R2)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	2.7pF (2R7)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	3.3pF (3R3)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	3.9pF (3R9)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	4.7pF (4R7)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	5.6pF (5R6)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	6.8pF (6R8)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	8.2pF (8R2)	N	N	S	S	A	A	A	A	B	B	B	B					D	D				
	10pF (100)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	12pF (120)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	15pF (150)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	18pF (180)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	22pF (220)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	27pF (270)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	33pF (330)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	39pF (390)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	47pF (470)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	56pF (560)	N	N	S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	68pF (680)	N		S	S	A	A	A	A	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	82pF (820)	N		S	S	A	A	B	B	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	100pF (101)	N		S	S	A	B	B	B	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	120pF (121)			S	S	A	B	D	D	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	150pF (151)			S	S	B	D	D	D	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	180pF (181)			S	S	B	D	D	D	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	220pF (221)			S	S	D	D	D	D	B	B	B	B	C	C	C	C	D	D	D	D	D	D
	270pF (271)			X	X	D	D	D	D	B	C	C	C	C	C	C	C	K	K	D	D	D	D
	330pF (331)			X	X	D	D	D	D	B	C	C	C	C	C	C	C	K	K	D	D	D	D
	390pF (391)			X	X	D	D	D	D	B	C	C	C	C	C	C	C	K	K	D	D	D	D
	470pF (471)			X	X	D	D	I	I	C	C	C	C	C	C	C	C	K	K	D	D	D	D
	560pF (561)			X	X	D	D	I	I	C	D	D	D	C	C	C	C	K	K	D	D	D	D
	680pF (681)					D	D	I	I	C	D	D	D	C	C	C	C	K	K	D	D	D	D
	820pF (821)					D	D	I	I	C	G	G	G	C	C	C	C	K	K	D	D	D	D
	1,000pF (102)					D	D	I	I	C	G	G	G	D	D	D	D	K	K	D	D	D	D
	1,200pF (122)					D	D			C	G	G	G	D	D	D	D	K	K	D	D	D	D
	1,500pF (152)					D	D			D	G	G	G	D	D	D	D	K	K	D	D	D	D
	1,800pF (182)					D	D			D	G	G	G	D	D	D	D	K	K	D	D	D	D
	2,200pF (222)					D	D			D	G	G	G	D	D	D	D	K	K	D	D	D	D
	2,700pF (272)									D	G			D	D	D	D			D	D	D	D
	3,300pF (332)									D	G			D	D	D	D			D	D	D	D
	3,900pF (392)									D	G			D	D	D	D			D	D	D	D
	4,700pF (472)									D	G			G	G					D	D	D	D
	5,600pF (562)													G	G					D	D	D	D
	6,800pF (682)													G	G					D	D	D	D
	8,200pF (822)													G	G							D	D
	0.010μF (103)													G	G							D	D
	0.022μF (223)													M	M							K	K
	0.033μF (333)													M	M							M	M

1. The letter in cell is expressed the symbol of product thickness.

7-2 X7R Dielectric

DIELECTRIC		X7R																							
SIZE		0603		0805				1206						1210						1808		1812			
RATED VOLTAGE (VDC)		200	250	200	250	500	630	200	250	400	450	500	630	200	250	400	450	500	630	500	630	200	250	500	630
Capacitance	100pF (101)	X	X	B	B	B	B	D	D			D	D	D	D			D	D						
	120pF (121)	X	X	B	B	B	B	D	D			D	D	D	D			D	D						
	150pF (151)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	180pF (181)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	220pF (221)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	270pF (271)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	330pF (331)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	390pF (391)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	470pF (471)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	560pF (561)	X	X	B	B	B	B	D	D			D	D	D	D			D	D	D	D				
	680pF (681)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D				
	820pF (821)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D				
	1,000pF (102)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	1,200pF (122)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	1,500pF (152)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	1,800pF (182)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	2,200pF (222)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	2,700pF (272)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	3,300pF (332)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	3,900pF (392)	X	X	B	B	B	B	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	4,700pF (472)	X	X	B	B	D	D	D	D			D	D	C	C			D	D	D	D	D	D	D	D
	5,600pF (562)	X	X	D	D	D	D	D	D			D	D	C	C			D	D	K	K	D	D	D	D
	6,800pF (682)	X	X	D	D	D	D	D	D			D	D	C	C			D	D	K	K	D	D	D	D
	8,200pF (822)	X	X	D	D	D	D	D	D			D	D	C	C			D	D	K	K	D	D	D	D
	0.010μF (103)	X	X	D	D	D	D	D	D			D	D	C	C			D	D	K	K	D	D	D	D
	0.012μF (123)			D	D	D	D	D	D			D	D	C	C			D	D	K	K	D	D	D	D
	0.015μF (153)			D	D	D	D	D	D			D	D	C	C			D	D	K	K	D	D	D	D
	0.018μF (183)			D	D	D	D	D	D			D	D	C	C			D	D	K	K	D	D	D	D
	0.022μF (223)			D	D	D	D	D	D			G	G	C	C			D	D	K	K	D	D	D	D
	0.027μF (273)			D	D			D	D			G	G	C	C			G	G	K	K	D	D	D	D
	0.033μF (333)			D	D			G	G			G	G	C	C			G	G	K	K	D	D	D	D
	0.039μF (393)			D	D			G	G			G	G	C	C			G	G	K	K	D	D	D	D
	0.047μF (473)			D	D			G	G			G	G	D	D			G	G	K	K	D	D	D	D
	0.056μF (563)			D	D			G	G			G	G	D	D			G	G	K	K	D	D	K	K
	0.068μF (683)			D	D			G	G	G	G			G	G			K	K	K	K	D	D	K	K
	0.082μF (823)			D				G	G	G	G			G	G			K	K	K	K	D	D	K	K
	0.10μF (104)			D				G	G	G	G			G	G			K	K			D	D	K	K
	0.12μF (124)							G	G					G	G	M	M	M	M			D	D	M	M
	0.15μF (154)							G	G					M	M	M	M	M	M			K	K	M	M
	0.18μF (184)							G	G					M	M	M	M					K	K	M	M
	0.22μF (224)							G	G					M	M	M	M					K	K	M	M
	0.27μF (274)													M	M	M	M					K	K	M	
	0.33μF (334)													M	M	M	M					K	K	M	
	0.39μF (394)													M	M							K	K	M	
	0.47μF (474)													M	M							K	K	M	
	0.56μF (564)													M	M							M	M		
	0.68μF (684)													M	M							M	M		
	0.84μF (844)																					M	M		
	1.0μF (105)																					M	M		

1. The letter in cell is expressed the symbol of product thickness.

7-3 Y5V Dielectric

DIELECTRIC		Y5V							
SIZE		0805		1206		1210		1812	
RATED VOLTAGE (VDC)		200	250	200	250	200	250	200	250
Capacitance	0.010μF (103)	B	B	B	B	C	C	D	D
	0.015μF (153)	B	B	B	B	C	C	D	D
	0.022μF (223)	B	B	B	B	C	C	D	D
	0.033μF (333)	B	B	B	B	C	C	D	D
	0.047μF (473)	B	B	B	B	C	C	D	D
	0.068μF (683)	B	B	B	B	C	C	D	D
	0.10μF (104)			B	B	C	C	D	D
	0.15μF (154)			C	C	C	C	D	D
	0.22μF (224)							D	D
	0.33μF (334)							D	D
	0.47μF (474)							D	D
	0.68μF (684)							D	D
	1.0μF (105)								

1. The letter in cell is expressed the symbol of product thickness.

8. CAPACITANCE RANGE (HIGH VOLTAGE - 1kV to 4kV)

8-1 NP0 Dielectric

DIELECTRIC		NP0																
SIZE		0805	1206			1210			1808					1812				
RATED VOLTAGE		1000	1000	1500	2000	1000	1500	2000	1000	1500	2000	3000	4000	1000	1500	2000	3000	4000
Capacitance	0.5pF (0R5)	D																
	1.0pF (1R0)	D																
	1.2pF (1R2)	D																
	1.5pF (1R5)	D	B	B	B													
	1.8pF (1R8)	D	B	B	B													
	2.0pF (2R0)	D	B	B	B				D	D	D	D	D					
	2.2pF (2R2)	D	B	B	B				D	D	D	D	D					
	2.7pF (2R7)	D	B	B	B				D	D	D	D	D					
	3.3pF (3R3)	D	B	B	B				D	D	D	D	D					
	3.9pF (3R9)	D	B	B	B				D	D	D	D	D					
	4.7pF (4R7)	D	B	B	B				D	D	D	D	D					
	5.6pF (5R6)	D	B	B	B				D	D	D	D	D					
	6.8pF (6R8)	D	B	B	B				D	D	D	D	D					
	8.2pF (8R2)	D	B	B	B				D	D	D	D	D					
	10pF (100)	D	B	B	B	C	C	C	D	D	D	D	D	D	D	D	D	D
	12pF (120)	D	B	B	B	C	C	C	D	D	D	D	D	D	D	D	D	D
	15pF (150)	D	B	B	B	C	C	C	D	D	D	D	D	D	D	D	D	D
	18pF (180)	D	B	B	B	C	C	C	D	D	D	D	D	D	D	D	D	D
	22pF (220)	D	B	B	B	C	C	C	D	D	D	D	G	D	D	D	D	D
	27pF (270)	D	B	B	B	C	C	C	D	D	D	D	G	D	D	D	D	D
	33pF (330)	D	B	C	C	C	C	C	D	D	D	D	K	D	D	D	D	D
	39pF (390)	D	B	C	C	C	C	C	D	D	D	D	K	D	D	D	D	D
	47pF (470)	D	C	C	C	C	C	C	D	D	D	D		D	D	D	D	G
	56pF (560)	D	C	D	D	C	D	D	D	D	D	D		D	D	D	D	G
	68pF (680)	D	C	D	D	C	D	D	D	D	D	D		D	D	D	D	K
	82pF (820)	D	D	D	D	C	D	D	D	D	D	D		D	D	D	D	K
	100pF (101)	D	D	D	D	D	D	D	D	D	K	K		D	D	D	D	
	120pF (121)	D	D	G	G	D	D	D	D	D	K	K		D	D	D	D	
	150pF (151)	D	D	G	G	D	G	G	D	K	K	K		D	D	D	D	
	180pF (181)	D	G	G	G	D	G	G	D	K	K	K		D	D	K	K	
	220pF (221)	D	G	G	G	G	G	G	D	K	K	K		D	D	K	K	
	270pF (271)	D	G	P	P	G	K	K	K	K	K	K		D	K	K	K	
	330pF (331)	D	G	P	P	G	K	K	K	K	K	K		D	K	K	K	
	390pF (391)	D	G	P	P	G	M	M	K	K	K			D	K	K	K	
	470pF (471)		G			G	M	M	K	K	K			K	K	K	K	
	560pF (561)		G			G			K	K	K			K	K	K		
	680pF (681)		G			G			K	K	K			K	K	K		
	820pF (821)		G			G			K					K	K	K		
	1,000pF (102)		G			G			K					K	K	K		
	1,200pF (122)					G								K				
	1,500pF (152)					K								K				
	1,800pF (182)					M								K				
	2,200pF (222)					M								K				
	2,700pF (272)					M								K				
	3,300pF (332)					M								K				
	3,900pF (392)					M								M				

1. The letter in cell is expressed the symbol of product thickness.

8-2 X7R Dielectric

DIELECTRIC		X7R																	
SIZE		0805	1206				1210			1808					1812				
RATED VOLTAGE		1000	1000	1500	2000	2500	1000	1500	2000	1000	1500	2000	3000	4000	1000	1500	2000	3000	4000
Capacitance	100pF (101)	B	D	D	D	D	D	D	D										
	120pF (121)	B	D	D	D	D	D	D	D										
	150pF (151)	B	D	D	D	D	D	D	D	D	D	D	D	K					
	180pF (181)	B	D	D	D	D	D	D	D	D	D	D	D	K					
	220pF (221)	B	D	D	D	D	D	D	D	D	D	D	D	K					
	270pF (271)	B	D	D	D	D	D	D	D	D	D	D	D	K	D	D	D	K	K
	330pF (331)	B	D	D	D	D	D	D	D	D	D	D	K	K	D	D	D	K	K
	390pF (391)	B	D	D	D	D	D	D	D	D	D	D	K	K	D	D	D	K	K
	470pF (471)	B	D	D	D	D	D	D	D	D	D	D	K	K	D	D	D	K	K
	560pF (561)	B	D	D	D	D	D	D	D	D	D	D	K	K	D	D	D	K	K
	680pF (681)	B	D	D	D	D	D	D	D	D	D	D	K	K	D	D	D	K	K
	820pF (821)	B	D	D	D	D	D	D	D	D	D	D	K	K	D	D	D	K	K
	1,000pF (102)	B	D	D	D	D	D	D	D	D	K	K	K	K	D	D	D	K	K
	1,200pF (122)	B	D	G	G	G	D	M	M	D	K	K	K		D	D	D	K	M
	1,500pF (152)	D	D	G	G	G	D	M	M	D	K	K	K		D	D	D	K	M
	1,800pF (182)	D	D	G	G	G	D	M	M	D	K	K	K		D	D	D	M	M
	2,200pF (222)	D	D	G	G	G	D	M	M	D	K	K			D	D	D	M	
	2,700pF (272)	D	D	G	G		D	M	M	D	K	K			D	D	D	M	
	3,300pF (332)	D	D	G	G		D	M	M	D	K	K			D	K	K	M	
	3,900pF (392)	D	D	G			G	M	M	D	K	K			D	K	K		
	4,700pF (472)	D	D	G			G	M	M	D	K	K			D	K	K		
	5,600pF (562)	D	D	G			G	M	M	K	K	K			D	M	M		
	6,800pF (682)	D	D	G			G	M	M	K	K	K			D	M	M		
	8,200pF (822)	D	D				G	M	M	K					D	M	M		
	0.010μF (103)		D				G			K					D	M	M		
	0.012μF (123)		G				G			K					K				
	0.015μF (153)		G				G			K					K				
	0.018μF (183)						G			K					M				
	0.022μF (223)						G			K					M				
	0.033μF (333)						K			K					M				
	0.047μF (473)						M			K					M				
	0.056μF (563)						M			K					M				
	0.068μF (683)						M								M				
	0.10μF (104)														M				

1. The letter in cell is expressed the symbol of product thickness.

9. PACKAGING DIMENSION AND QUANTITY

Size	Thickness/Symbol (mm)		Paper tape		Plastic tape	
			7" reel	13" reel	7" reel	13" reel
0402	0.50±0.05	N	10k	50k	-	-
0603	0.80±0.07	S	4k	15k	-	-
	0.80 +0.15/-0.10	X	4k	15k		
0805	0.60±0.10	A	4k	15k	-	-
	0.80±0.10	B	4k	15k	-	-
	1.25±0.10	D	-	-	3k	10k
	1.25±0.20	I	-	-	3k	10k
1206	0.80±0.10	B	4k	15k	-	-
	0.95±0.10	C	-	-	3k	10k
	1.25±0.10	D	-	-	3k	10k
	1.60±0.20	G	-	-	2k	10k
1210	0.95±0.10	C	-	-	3k	10k
	1.25±0.10	D	-	-	3k	10k
	1.60±0.20	G	-	-	2k	-
	2.00±0.20	K	-	-	1k	6k
	2.50±0.30	M	-	-	1k	6k
1808	1.25±0.10	D	-	-	2k	10k
	2.00±0.20	K	-	-	1k	6k
1812	1.25±0.10	D	-	-	1k	5k
	1.60±0.20	G	-	-	1k	-
	2.00±0.20	K	-	-	1k	-
	2.50±0.30	M	-	-	0.5k	3k

Unit: pieces

10. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

<table>
<tr><th>No.</th><th>Item</th><th>Test Condition</th><th>Requirements</th></tr>
<tr><td>1.</td><td>Visual and Mechanical</td><td>---</td><td>* No remarkable defect.
* Dimensions to conform to individual specification sheet.</td></tr>
<tr><td>2.</td><td>Capacitance</td><td>Class I: (NP0)</td><td>* Shall not exceed the limits given in the detailed spec.</td></tr>
<tr><td>3.</td><td>Q/ D.F. (Dissipation Factor)</td><td>Cap≤1000pF, 1.0±0.2Vrms, 1MHz±10%
Cap>1000pF, 1.0±0.2Vrms, 1KHz±10%
Class II: (X7R, Y5V)
1.0±0.2Vrms, 1kHz±10%
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .</td><td>NP0: Cap≥30pF, Q≥1000; Cap<30pF, Q≥400+20C
X7R: ≤2.5%
Y5V: ≤5.0%</td></tr>
<tr><td>4.</td><td>Dielectric Strength</td><td>* To apply voltage:
200V~300V ≥2 times VDC
400V~450V ≥1.2 times VDC
500V~999V ≥1.5 times VDC
1000V~3000V ≥1.2 times VDC
4000V ≥1.1 times VDC
* Duration: 1 to 5 sec.
* Charge & discharge current less than 50mA.</td><td>* No evidence of damage or flash over during test.</td></tr>
<tr><td>5.</td><td>Insulation Resistance</td><td>Rated voltage: 200~630V — To apply rated voltage (500V max.) for 60 sec.
Rated voltage: ≥630V — To apply 500V for 60 sec.</td><td>≥10GΩ or RxC≥100Ω-F whichever is smaller</td></tr>
<tr><td>6.</td><td>Temperature Coefficient</td><td>With no electrical load.
<table>
<tr><th>T.C.</th><th>Operating Temp</th></tr>
<tr><td>NP0</td><td>-55~125℃ at 25℃</td></tr>
<tr><td>X7R</td><td>-55~125℃ at 25℃</td></tr>
<tr><td>Y5V</td><td>-25~85℃ at 20℃</td></tr>
</table>
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .</td><td>
<table>
<tr><th>T.C.</th><th>Capacitance Change</th></tr>
<tr><td>NP0</td><td>Within ±30ppm/℃</td></tr>
<tr><td>X7R</td><td>Within ±15%</td></tr>
<tr><td>Y5V</td><td>Within +30%/-80%</td></tr>
</table>
</td></tr>
<tr><td>7.</td><td>Adhesive Strength of Termination</td><td>* Pressurizing force：
5N (≤0603) and 10N (>0603)
* Test time: 10±1 sec.</td><td>* No remarkable damage or removal of the terminations.</td></tr>
<tr><td>8.</td><td>Vibration Resistance</td><td>* Vibration frequency: 10~55 Hz/min.
* Total amplitude: 1.5mm
* Test time: 6 hrs. (Two hrs each in three mutually perpendicular directions.)
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .
Cap./DF(Q) Measurement to be made after de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp.</td><td> No remarkable damage.
* Cap change and Q/D.F.: To meet initial spec.</td></tr>
<tr><td>9.</td><td>Solderability</td><td>* Solder temperature: 235±5℃
* Dipping time: 2±0.5 sec.</td><td>95% min. coverage of all metalized area.</td></tr>
<tr><td>10.</td><td>Bending Test</td><td>* The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm per second until the deflection becomes 1 mm and then the pressure shall be maintained for 5±1 sec.
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .
* Measurement to be made after keeping at room temp. for 24±2 hrs.</td><td>* No remarkable damage.
* Cap change：
NP0: within ±5.0% or ±0.5pF whichever is larger.
X7R: within ±12.5%
Y5V: within ±30%
(This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test.)</td></tr>
<tr><td>11.</td><td>Resistance to Soldering Heat</td><td>* Solder temperature: 260±5℃
* Dipping time: 10±1 sec
* Preheating: 120 to 150℃ for 1 minute before imme rse the capacitor in a eutectic solder.
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .
Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp.</td><td> No remarkable damage.
* Cap change:
NP0: within ±2.5% or ±0.25pF whichever is larger.
X7R: within ±7.5%
Y5V: within ±20%
* Q/D.F., I.R. and dielectric strength: To meet initial requirements.
* 25% max. leaching on each edge.</td></tr>
</table>

<table>
<tr><th>No.</th><th>Item</th><th>Test Condition</th><th>Requirements</th></tr>
<tr><td>12.</td><td>Temperature Cycle</td><td>* Conduct the five cycles according to the temperatures and time.
<table><tr><th>Step</th><th>Temp. (℃)</th><th>Time (min.)</th></tr><tr><td>1</td><td>Min. operating temp. +0/-3</td><td>30±3</td></tr><tr><td>2</td><td>Room temp.</td><td>2~3</td></tr><tr><td>3</td><td>Max. operating temp. +3/-0</td><td>30±3</td></tr><tr><td>4</td><td>Room temp.</td><td>2~3</td></tr></table>*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .
* Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .</td><td>* No remarkable damage.
* Cap change：
NP0: within ±2.5% or ±0.25pF whichever is larger.
X7R: within ±7.5%
Y5V: within ±20%
* Q/D.F., I.R. and dielectric strength: To meet initial requirements.</td></tr>
<tr><td>13.</td><td>Humidity (Damp Heat) Steady State</td><td>* Test temp.: 40±2℃
* Humidity: 90~95% RH
* Test time: 500+24/-0hrs.
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .
* Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .</td><td>* No remarkable damage.
* Cap change: NP0: within ±5.0% or ±0.5pF whichever is larger.
X7R: within ±12.5%
Y5V: within ±30%
* Q/D.F. value:
NP0: Cap≥30pF, Q≥350; 10pF≤Cap<30pF, Q≥275+2.5C
Cap<10pF; Q≥200+10C
X7R: ≤3.0%
Y5V: ≤7.5%
* I.R.: ≥1GΩ or RxC≥50Ω-F whichever is smaller.</td></tr>
<tr><td>14.</td><td>Humidity (Damp Heat) Load</td><td>* Test temp.: 40±2℃
* Humidity: 90~95%RH
* Test time: 500+24/-0 hrs.
* To apply voltage：rated voltage (Max. 500V)
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .
* Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .</td><td>* No remarkable damage.
* Cap change: NP0: within ±7.5% or ±0.75pF whichever is larger.
X7R: within ±12.5%
Y5V: within ±30%
* Q/D.F. value:
NP0: Cap≥30pF, Q≥200; Cap<30pF, Q≥100+10/3C
X7R: ≤3.0%
Y5V: ≤7.5%
* I.R.: ≥500MΩ or RxC≥25Ω-F whichever is smaller.</td></tr>
<tr><td>15.</td><td>High Temperature Load (Endurance)</td><td>* Test temp.:
NP0, X7R: 125±3℃
Y5V: 85±3℃
* To apply voltage:
(1) 1206/NP0 (3kV) ≥1.5pF: 100% of rated voltage.
(2) 200V~300V: 200% of rated voltage.
(3) 400V~450V: 120% of rated voltage.
(4) 500V: 150% of rated voltage.
(5) 630V~3000V: 120% of rated voltage.
(6) 4000V: 110% of rated voltage.
* Test time: 1000+24/-0 hrs.
*Before initial measurement (Class II only): To apply de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp .
* Cap. / DF(Q) / I.R. Measurement to be made after de-aging at 150℃ for 1hr then set for 24±2 hrs at room temp.</td><td>* No remarkable damage.
* Cap change: NP0: within ±3.0% or ±0.3pF whichever is larger.
X7R: within ±12.5%
Y5V: within ±30%
* Q/D.F. value:
NP0: Cap≥30pF, Q≥350
10pF≤Cap<30pF, Q≥275+2.5C
Cap<10pF, Q≥200+10C
X7R: ≤3.0%
Y5V: ≤7.5%
* I.R.: ≥1GΩ or RxC≥50Ω-F whichever is smaller.</td></tr>
</table>

APPENDIXES

◙ Tape & reel dimensions

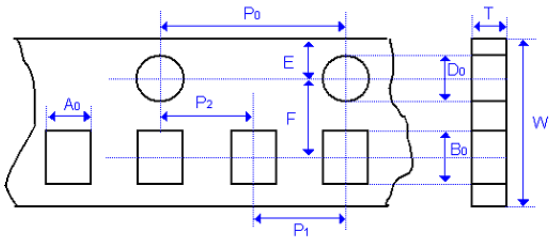


Fig. 2 The dimension of paper tape

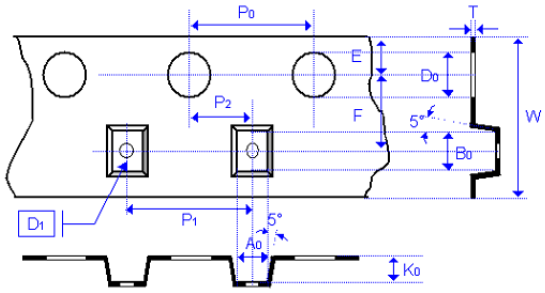


Fig. 3 The dimension of plastic tape

Size	0201	0402	0603	0805			1206			1210			1808	1812	
Thickness	L	N,E	S,H,X	A,H	B,T	D,I	B,T	C,J,D	G,P	T	C,D,G,K	M	D,F, G,K	D,F, G,K	M,U
A_0	0.39 +/-0.07	0.70 +/-0.2	1.05 +/-0.30	1.50 +/-0.20	1.50 +/-0.20	< 1.80	1.90 +/-0.50	< 2.00	<2.30	< 3.05	< 3.05	< 3.20	< 2.50	< 3.90	< 3.90
B_0	0.69 +/-0.07	1.20 +/-0.2	1.80 +/-0.30	2.30 +/-0.20	2.30 +/-0.20	< 2.70	3.50 +/-0.50	< 3.70	< 4.00	< 3.80	< 3.80	<3.95	< 5.30	< 5.30	< 5.30
T	≦0.50	≦0.80	≦1.20	≦1.15	≦1.30	0.23 +/-0.1	≦1.30	0.23 +/-0.1	0.23 +/-0.1	0.23 +/-0.1	0.23 +/-0.1	0.23 +/-0.1	0.25 +/-0.1	0.25 +/-0.1	0.25 +/-0.1
K_0	-	-	-	-	-	< 2.50	-	< 2.50	< 2.50	< 1.50	< 2.50	< 3.00	< 2.50	< 2.50	< 3.50
W	8.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.20	8.00 +/-0.10	8.00 +/-0.20	8.00 +/-0.20	8.00 +/-0.20	8.00 +/-0.20	8.00 +/-0.20	12.00 +/-0.20	12.00 +/-0.20	12.00 +/-0.20
P_0	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10
$10xP_0$	40.00 +/-0.10	40.00 +/-0.10	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20	40.00 +/-0.20
P_1	2.00 +/-0.05	2.00 +/-0.05	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	4.00 +/-0.10	8.00 +/-0.10	8.00 +/-0.10
P_2	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.05	2.00 +/-0.10	2.00 +/-0.10	2.00 +/-0.10
D_0	1.55 +/-0.05	1.55 +/-0.05	1.55 +/-0.05	1.55 +/-0.05	1.55 +/-0.05	1.50 +0.1/-0	1.55 +/-0.05	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0	1.50 +0.1/-0
D_1	-	-	-	-	-	1.00 +/-0.10	-	1.00 +/-0.10	1.00 +/-0.10	1.00 +/-0.10	1.00 +/-0.10	1.00 +/-0.10	1.50 +/-0.10	1.50 +/-0.10	1.50 +/-0.10
E	1.75 +/-0.05	1.75 +/-0.05	1.75 +/-0.05	1.75 +/-0.05	1.75 +/-0.05	1.75 +/-0.10	1.75 +/-0.05	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10	1.75 +/-0.10
F	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	3.50 +/-0.05	5.50 +/-0.10	5.50 +/-0.10	5.50 +/-0.10

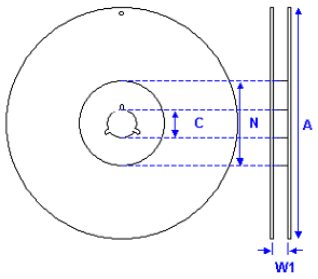
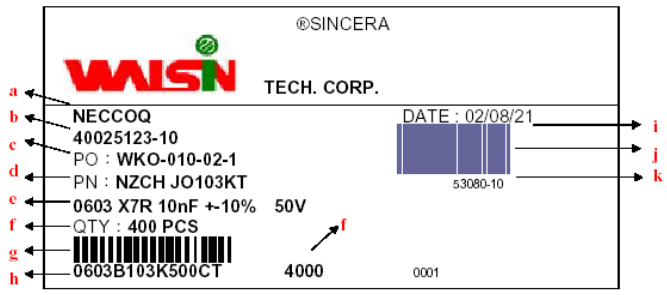


Fig. 4 The dimension of reel

Size	0402, 0603, 0805, 1206, 1210			1808, 1812
Reel size	7”	10”	13”	7”
C	13.0+0.5/-0.2	13.0+0.5/-0.2	13.0+0.5/-0.2	13.0+0.5/-0.2
W_1	8.4+1.5/-0	8.4+1.5/-0	8.4+1.5/-0	12.4+2.0/-0
A	178.0±1.00	250.0±1.0	330.0±1.0	178.0±1.00
N	60.0+1/-0	100.0±1.0	100±1.0	60.5±1.0

◙ Description of customer label



a. Customer name
b. WTC order series and item number
c. Customer P/O
d. Customer P/N
e. Description of product
f. Quantity
g. Bar code including quantity & WTC P/N or customer
h. WTC P/N
i. Shipping date
j. Order bar code including series and item numbers
k. Serial number of label

◙ Constructions

No.	Name		NPO, X7R, Y5V
①	Ceramic material		$BaTiO_3$ based
②	Inner electrode		Ni
③	Termination	Inner layer	Cu
④		Middle layer	Ni
⑤		Outer layer	Sn

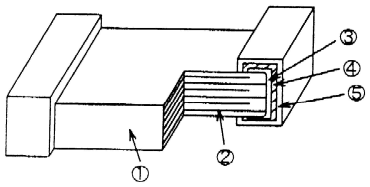


Fig. 5 The construction of MLCC

◙ Storage and handling conditions

(1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions.
(2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

Cautions:

a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight,the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.

◙ Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N_2 within oven are recommended.

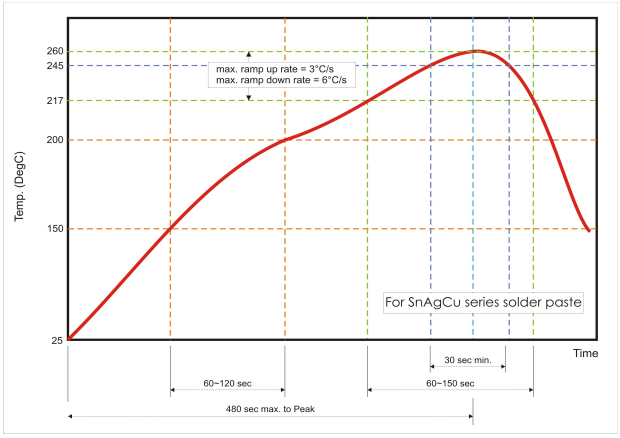


Fig. 6 Recommended reflow soldering profile for SMT process with SnAgCu series solder paste.

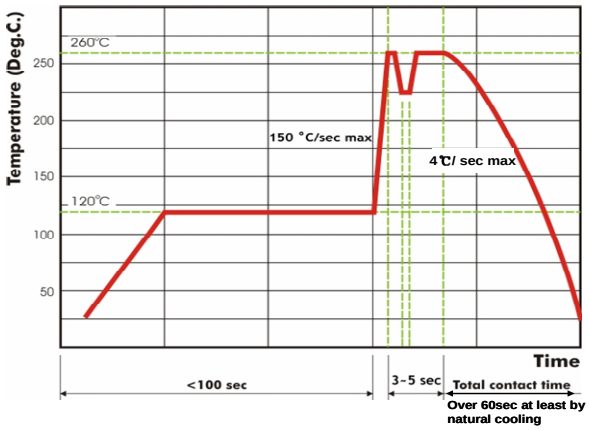


Fig. 7 Recommended wave soldering profile for SMT process with SnAgCu series solder.